

# LTC1159

## LTC1159-3.3/LTC1159-5

### ABSOLUTE MAXIMUM RATINGS (Note 1)

|                                              |              |                                            |                |
|----------------------------------------------|--------------|--------------------------------------------|----------------|
| Input Supply Voltage (Pin 2) .....           | –15V to 60V  | Operating Temperature Range                |                |
| V <sub>CC</sub> Output Current (Pin 3) ..... | 50mA         | LTC1159C .....                             | 0°C to 70°C    |
| Continuous Pin Currents (Any Pin) .....      | 50mA         | LTC1159I .....                             | –40°C to 85°C  |
| Sense Voltages .....                         | –0.3V to 13V | Extended Commercial                        |                |
| Shutdown Voltages .....                      | 7V           | Temperature Range .....                    | –40°C to 85°C  |
| EXTV <sub>CC</sub> Input Voltage .....       | 15V          | Storage Temperature Range .....            | –65°C to 150°C |
| Junction Temperature (Note 2) .....          | 125°C        | Lead Temperature (Soldering, 10 sec) ..... | 300°C          |

### PACKAGE/ORDER INFORMATION

| TOP VIEW                                                                                         | ORDER PART NUMBER                                  | TOP VIEW                                                                                                                                                                                                               | ORDER PART NUMBER                                                                                                                                  |
|--------------------------------------------------------------------------------------------------|----------------------------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------|
| <p>G PACKAGE<br/>20-LEAD PLASTIC SSOP<br/>T<sub>JMAX</sub> = 125°C, θ<sub>JA</sub> = 135°C/W</p> | <p>LTC1159CG<br/>LTC1159CG-3.3<br/>LTC1159CG-5</p> | <p>N PACKAGE<br/>16-LEAD PDIP<br/>S PACKAGE<br/>16-LEAD PLASTIC SO<br/>*FIXED OUTPUT VERSIONS<br/>T<sub>JMAX</sub> = 125°C, θ<sub>JA</sub> = 80°C/W (N)<br/>T<sub>JMAX</sub> = 125°C, θ<sub>JA</sub> = 110°C/W (S)</p> | <p>LTC1159CN<br/>LTC1159CN-3.3<br/>LTC1159CN-5<br/>LTC1159CS<br/>LTC1159CS-3.3<br/>LTC1159CS-5<br/>LTC1159IS<br/>LTC1159IS-3.3<br/>LTC1159IS-5</p> |

Consult LTC Marketing for parts specified with wider operating temperature ranges.

### ELECTRICAL CHARACTERISTICS

The ● denotes specifications which apply over the full operating temperature range, otherwise specifications are at T<sub>A</sub> = 25°C. V<sub>IN</sub> = 12V, V<sub>SHDN1</sub> = 0V (Note 3), unless otherwise noted.

| SYMBOL              | PARAMETER                               | CONDITIONS                                     | MIN  | TYP  | MAX  | UNITS             |
|---------------------|-----------------------------------------|------------------------------------------------|------|------|------|-------------------|
| V <sub>FB</sub>     | Feedback Voltage (LTC1159 Only)         | ●                                              | 1.21 | 1.25 | 1.29 | V                 |
| I <sub>FB</sub>     | Feedback Current (LTC1159 Only)         | ●                                              |      | 0.2  |      | μA                |
| V <sub>OUT</sub>    | Regulated Output Voltage                | V <sub>IN</sub> = 9V                           | ●    | 3.23 | 3.33 | V                 |
|                     | LTC1159-3.3                             | I <sub>LOAD</sub> = 700mA                      | ●    | 4.90 | 5.05 | V                 |
|                     | LTC1159-5                               | I <sub>LOAD</sub> = 700mA                      |      |      | 5.20 |                   |
| ΔV <sub>OUT</sub>   | Output Voltage Line Regulation          | V <sub>IN</sub> = 9V to 40V                    |      | –40  | 0    | mV                |
|                     | Output Voltage Load Regulation          |                                                | ●    | 40   | 65   | mV                |
|                     | LTC1159-3.3                             | 5mA < I <sub>LOAD</sub> < 2A                   | ●    | 60   | 100  | mV                |
|                     | LTC1159-5                               | 5mA < I <sub>LOAD</sub> < 2A                   |      |      |      |                   |
|                     | Burst Mode Output Ripple                | I <sub>LOAD</sub> = 0A                         |      | 50   |      | mV <sub>P-P</sub> |
| I <sub>IN</sub>     | V <sub>IN</sub> Pin Current (Note 4)    | V <sub>IN</sub> = 12V, EXTV <sub>CC</sub> = 5V |      | 200  |      | μA                |
|                     | Normal Mode                             | V <sub>IN</sub> = 40V, EXTV <sub>CC</sub> = 5V |      | 300  |      | μA                |
|                     | Shutdown                                | V <sub>IN</sub> = 12V, V <sub>SHDN2</sub> = 2V |      | 15   |      | μA                |
|                     |                                         | V <sub>IN</sub> = 40V, V <sub>SHDN2</sub> = 2V |      | 25   |      | μA                |
| I <sub>EXTVCC</sub> | EXTV <sub>CC</sub> Pin Current (Note 4) | EXTV <sub>CC</sub> = 5V, Sleep Mode            |      | 250  |      | μA                |

# ELECTRICAL CHARACTERISTICS

The ● denotes specifications which apply over the full operating temperature range, otherwise specifications are at  $T_A = 25^\circ\text{C}$ .  $V_{IN} = 12\text{V}$ ,  $V_{SHDN1} = 0\text{V}$  (Note 3), unless otherwise noted.

| SYMBOL                    | PARAMETER                                            | CONDITIONS                                                                                                                 | MIN          | TYP       | MAX      | UNITS                          |
|---------------------------|------------------------------------------------------|----------------------------------------------------------------------------------------------------------------------------|--------------|-----------|----------|--------------------------------|
| $V_{CC}$                  | Internal Regulator Voltage                           | $V_{IN} = 12\text{V}$ to $40\text{V}$ , $EXTV_{CC} = 0\text{V}$ , $I_{CC} = 10\text{mA}$                                   | 4.25         | 4.5       | 4.75     | V                              |
| $V_{IN} - V_{CC}$         | $V_{CC}$ Dropout Voltage                             | $V_{IN} = 4\text{V}$ , $EXTV_{CC} = \text{Open}$ , $I_{CC} = 10\text{mA}$                                                  |              | 300       | 400      | mV                             |
| $V_{EXT} - V_{CC}$        | $EXTV_{CC}$ Switch Drop                              | $V_{IN} = 12\text{V}$ , $EXTV_{CC} = 5\text{V}$ , $I_{SWITCH} = 10\text{mA}$                                               |              | 250       | 350      | mV                             |
| $V_{P-GATE} - V_{IN}$     | P-Gate to Source Voltage (Off)                       | $V_{IN} = 12\text{V}$<br>$V_{IN} = 40\text{V}$                                                                             | -0.2<br>-0.2 | 0<br>0    |          | V<br>V                         |
| $V_{SENSE+} - V_{SENSE-}$ | Current Sense Threshold Voltage<br>LTC1159           | $V_{SENSE-} = 5\text{V}$ , $V_{FB} = 1.32\text{V}$ (Forced)<br>$V_{SENSE-} = 5\text{V}$ , $V_{FB} = 1.15\text{V}$ (Forced) | ● 130        | 25<br>150 | 170      | mV<br>mV                       |
|                           | LTC1159-3.3                                          | $V_{SENSE-} = 3.4\text{V}$ (Forced)<br>$V_{SENSE-} = 3.1\text{V}$ (Forced)                                                 | ● 130        | 25<br>150 | 170      | mV<br>mV                       |
|                           | LTC1159-5                                            | $V_{SENSE-} = 5.2\text{V}$ (Forced)<br>$V_{SENSE-} = 4.7\text{V}$ (Forced)                                                 | ● 130        | 25<br>150 | 170      | mV<br>mV                       |
| $V_{SHDN1}$               | SHDN1 Threshold<br>LTC1159CG, LTC1159-3.3, LTC1159-5 |                                                                                                                            | 0.5          | 0.8       | 2        | V                              |
| $V_{SHDN2}$               | SHDN2 Threshold                                      |                                                                                                                            | 0.8          | 1.4       | 2        | V                              |
| $I_{SHDN2}$               | Shutdown 2 Input Current                             | $V_{SHDN2} = 5\text{V}$                                                                                                    |              | 12        | 20       | $\mu\text{A}$                  |
| $I_{CT}$                  | $C_T$ Pin Discharge Current                          | $V_{OUT}$ in Regulation<br>$V_{OUT} = 0\text{V}$                                                                           | 50           | 70<br>2   | 90<br>10 | $\mu\text{A}$<br>$\mu\text{A}$ |
| $t_{OFF}$                 | Off-Time (Note 5)                                    | $C_T = 390\text{pF}$ , $I_{LOAD} = 700\text{mA}$ , $V_{IN} = 10\text{V}$                                                   | 4            | 5         | 6        | $\mu\text{s}$                  |
| $t_r, t_f$                | Driver Output Transition Times                       | $C_L = 3000\text{pF}$ (Pins P-Drive and N-Gate), $V_{IN} = 6\text{V}$                                                      |              | 100       | 200      | ns                             |

## $-40^\circ\text{C} \leq T_A \leq 85^\circ\text{C}$ (Note 6)

| SYMBOL                    | PARAMETER                                            | CONDITIONS                                                                                         | MIN          | TYP          | MAX          | UNITS                          |
|---------------------------|------------------------------------------------------|----------------------------------------------------------------------------------------------------|--------------|--------------|--------------|--------------------------------|
| $V_{FB}$                  | Feedback Voltage (LTC1159 Only)                      |                                                                                                    | 1.2          | 1.25         | 1.3          | V                              |
| $V_{OUT}$                 | Regulated Output Voltage<br>LTC1159-3.3<br>LTC1159-5 | $V_{IN} = 9\text{V}$<br>$I_{LOAD} = 700\text{mA}$<br>$I_{LOAD} = 700\text{mA}$                     | 3.17<br>4.85 | 3.30<br>5.05 | 3.43<br>5.25 | V<br>V                         |
| $I_{IN}$                  | $V_{IN}$ Pin Current (Note 4)<br>Normal              | $V_{IN} = 12\text{V}$ , $EXTV_{CC} = 5\text{V}$<br>$V_{IN} = 40\text{V}$ , $EXTV_{CC} = 5\text{V}$ |              | 200<br>300   |              | $\mu\text{A}$<br>$\mu\text{A}$ |
|                           | Shutdown                                             | $V_{IN} = 12\text{V}$ , $V_{SHDN2} = 2\text{V}$<br>$V_{IN} = 40\text{V}$ , $V_{SHDN2} = 2\text{V}$ |              | 15<br>25     |              | $\mu\text{A}$<br>$\mu\text{A}$ |
| $I_{EXTVCC}$              | $EXTV_{CC}$ Pin Current (Note 4)                     | $EXTV_{CC} = 5\text{V}$ , Sleep Mode                                                               |              | 250          |              | $\mu\text{A}$                  |
| $V_{CC}$                  | Internal Regulator Voltage                           | $V_{IN} = 12\text{V}$ to $40\text{V}$ , $EXTV_{CC} = 0\text{V}$ , $I_{CC} = 10\text{mA}$           |              | 4.5          |              | V                              |
| $V_{SENSE+} - V_{SENSE-}$ | Current Sense Threshold Voltage                      | Low Threshold (Forced)<br>High Threshold (Forced)                                                  | 125          | 25<br>150    | 175          | mV<br>mV                       |
| $V_{SHDN2}$               | SHDN2 Threshold                                      |                                                                                                    | 0.8          | 1.4          | 2            | V                              |
| $t_{OFF}$                 | Off-Time (Note 5)                                    | $C_T = 390\text{pF}$ , $I_{LOAD} = 700\text{mA}$ , $V_{IN} = 10\text{V}$                           | 3.5          | 5            | 6.5          | $\mu\text{s}$                  |

**Note 1:** Absolute Maximum Ratings are those values beyond which the life of a device may be impaired.

**Note 2:**  $T_J$  is calculated from the ambient temperature  $T_A$  and power dissipation  $P_D$  according to the following formulas:  
 LTC1159CG, LTC1159CG-3.3, LTC1159CG-5:  $T_J = T_A + (P_D \cdot 135^\circ\text{C/W})$   
 LTC1159CN, LTC1159CN-3.3, LTC1159CN-5:  $T_J = T_A + (P_D \cdot 80^\circ\text{C/W})$   
 LTC1159CS, LTC1159CS-3.3, LTC1159CS-5:  $T_J = T_A + (P_D \cdot 110^\circ\text{C/W})$

**Note 3:** On LTC1159 versions which have a SHDN1 pin, it must be at ground potential for testing.

**Note 4:** The LTC1159  $V_{IN}$  and  $EXTV_{CC}$  current measurements exclude MOSFET driver currents. When  $V_{CC}$  power is derived from the output via  $EXTV_{CC}$ , the input current increases by  $(I_{GATECHG} \cdot \text{Duty Cycle})/(\text{Efficiency})$ . See Typical Performance Characteristics and Applications Information.

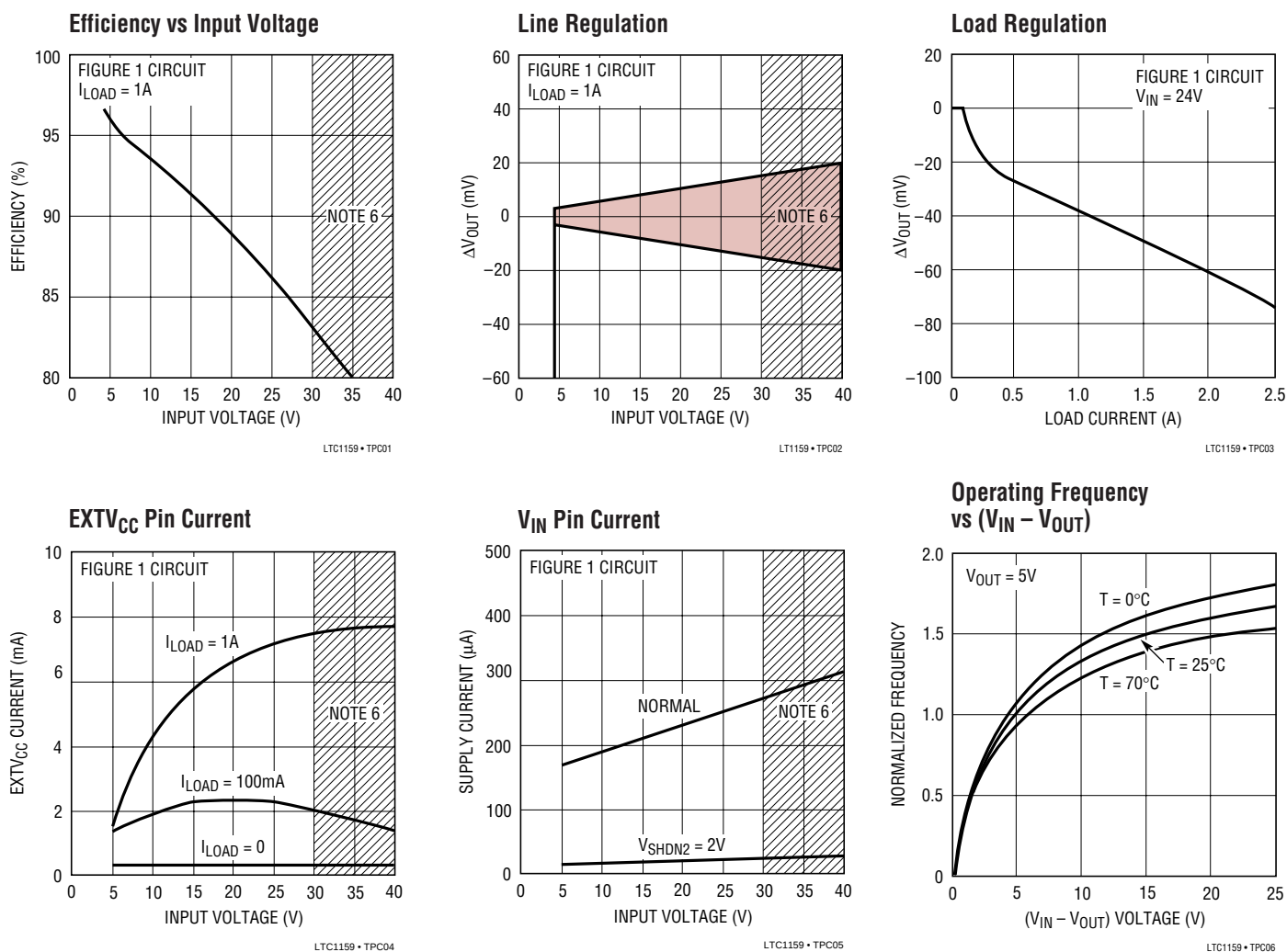
**Note 5:** In applications where  $R_{SENSE}$  is placed at ground potential, the off-time increases approximately 40%.

### ELECTRICAL CHARACTERISTICS

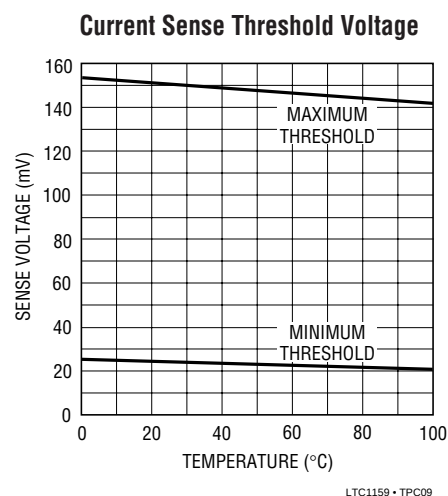
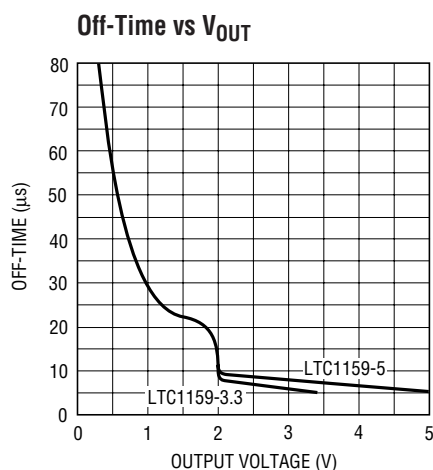
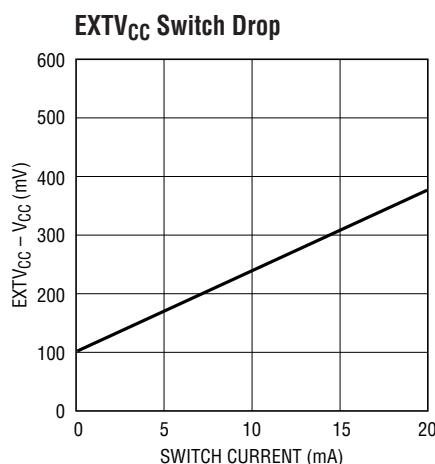
**Note 6:** The LTC1159C, LTC1159C-3.3, and LTC1159C-5 are not tested and not quality assurance sampled at  $-40^{\circ}\text{C}$  and  $85^{\circ}\text{C}$ . These specifications are guaranteed by design and/or correlation. The LTC1159I, LTC1159I-3.3 and LTC1159I-5 are guaranteed and tested over the  $-40^{\circ}\text{C}$  to  $85^{\circ}\text{C}$  operating temperature range.

**Note 7:** The logic-level power MOSFETs shown in Figure 1 are rated for  $V_{\text{DS(MAX)}} = 30\text{V}$ . For operation at  $V_{\text{IN}} > 30\text{V}$ , use standard threshold MOSFETs with  $\text{EXTV}_{\text{CC}}$  powered from a 12V supply. See Applications Information.

### TYPICAL PERFORMANCE CHARACTERISTICS



## TYPICAL PERFORMANCE CHARACTERISTICS



## PIN FUNCTIONS

**V<sub>IN</sub>:** Main Supply Input Pin.

**SGND:** Small-Signal Ground. Must be routed separately from other grounds to the (–) terminal of C<sub>OUT</sub>.

**PGND:** Driver Power Grounds. Connect to source of N-channel MOSFET and the (–) terminal of C<sub>IN</sub>.

**V<sub>CC</sub>:** Outputs of internal 4.5V linear regulator, EXTV<sub>CC</sub> switch, and supply inputs for driver and control circuits. The driver and control circuits are powered from the higher of the 4.5V regulator or EXTV<sub>CC</sub> voltage. Must be closely decoupled to power ground.

**C<sub>T</sub>:** External capacitor C<sub>T</sub> from this pin to ground sets the operating frequency. (The frequency is also dependent on the ratio V<sub>OUT</sub>/V<sub>IN</sub>.)

**I<sub>TH</sub>:** Gain Amplifier Decoupling Point. The current comparator threshold increases with the I<sub>TH</sub> pin voltage.

**V<sub>FB</sub>:** For the LTC1159 adjustable version, the V<sub>FB</sub> pin receives the feedback voltage from an external resistive divider used to set the output voltage.

**SENSE<sup>–</sup>:** Connects to internal resistive divider which sets the output voltage in fixed output versions. The SENSE<sup>–</sup> pin is also the (–) input of the current comparator.

**SENSE<sup>+</sup>:** The (+) Input for the Current Comparator. A built-in offset between the SENSE<sup>+</sup> and SENSE<sup>–</sup> pins, in conjunction with R<sub>SENSE</sub>, sets the current trip threshold.

**N-Gate:** High Current Drive for the Bottom N-Channel MOSFET. The N-Gate pin swings from ground to V<sub>CC</sub>.

**P-Gate:** Level-Shifted Gate Drive Signal for the Top P-Channel MOSFET. The voltage swing at the P-gate pin is from V<sub>IN</sub> to V<sub>IN</sub> – V<sub>CC</sub>.

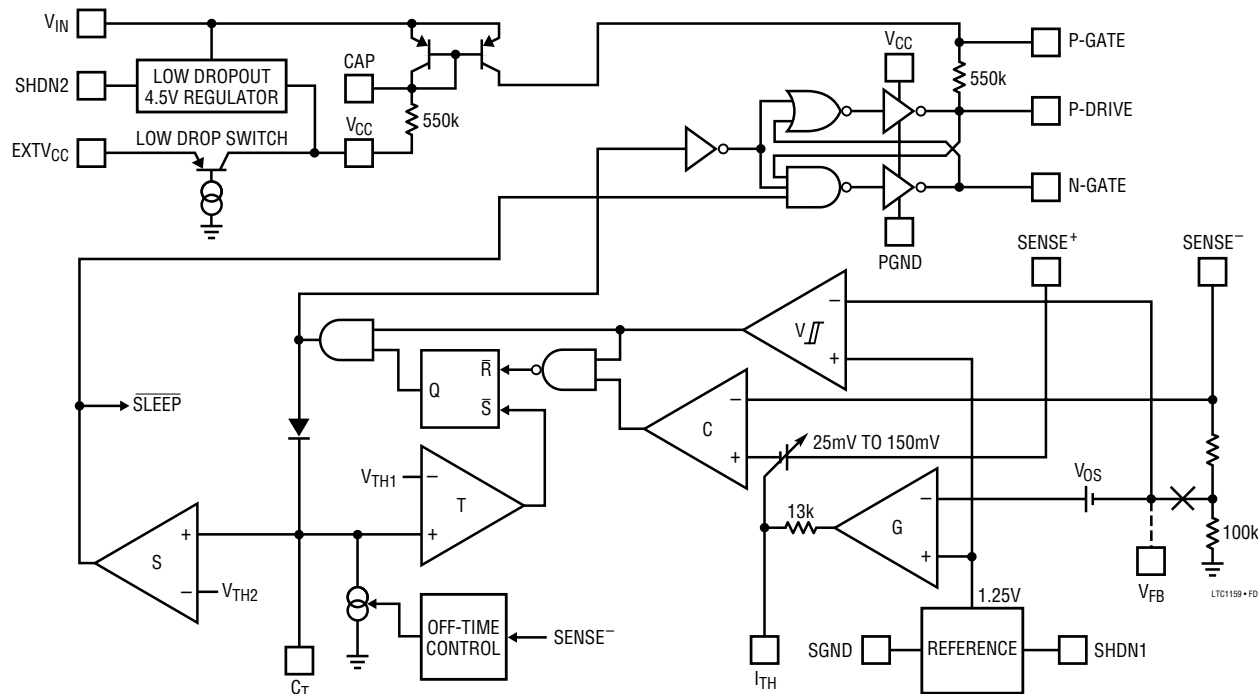
**P-Drive:** High Current Gate Drive for the Top P-Channel MOSFET. The P-drive pin(s) swing(s) from V<sub>CC</sub> to ground.

**CAP:** Charge Compensation Pin. A capacitor to V<sub>CC</sub> provides charge required by the P-gate level-shift capacitor during supply transitions. *The charge compensation capacitor must be larger than the gate drive capacitor.*

**SHDN1:** This pin shuts down the control circuitry only (V<sub>CC</sub> is not affected). Taking SHDN1 pin high turns off the control circuitry and holds both MOSFETs off. This pin must be at ground potential for normal operation.

**SHDN2:** Master Shutdown Pin. Taking SHDN2 high shuts down V<sub>CC</sub> and all control circuitry.

## FUNCTIONAL DIAGRAM Internal divider broken at $V_{FB}$ for adjustable versions.



## OPERATION (Refer to Functional Diagram)

The LTC1159 uses a current mode, constant off-time architecture to synchronously switch an external pair of complementary power MOSFETs. Operating frequency is set by an external capacitor at the  $C_T$  pin.

The output voltage is sensed either by an internal voltage divider connected to the SENSE<sup>-</sup> pin (LTC1159-3.3 and LTC1159-5) or an external divider returned to the  $V_{FB}$  pin (LTC1159). A voltage comparator V, and a gain block G, compare the divided output voltage with a reference voltage of 1.25V. To optimize efficiency, the LTC1159 automatically switches between two modes of operation, burst and continuous.

A low dropout 4.5V regulator provides the operating voltage  $V_{CC}$  for the MOSFET drivers and control circuitry during start-up. During normal operation, the LTC1159 family powers the drivers and control from the output via the EXT $V_{CC}$  pin to improve efficiency. The N-GATE pin is referenced to ground and drives the N-channel MOSFET gate directly. The P-channel gate drive must be referenced to the main supply input  $V_{IN}$ , which is accomplished by

level-shifting the P-drive signal via an internal 550k resistor and external capacitor.

During the switch “ON” cycle in continuous mode, current comparator C monitors the voltage between the SENSE<sup>+</sup> and SENSE<sup>-</sup> pins connected across an external shunt in series with the inductor. When the voltage across the shunt reaches its threshold value, the P-gate output is switched to  $V_{IN}$ , turning off the P-channel MOSFET. The timing capacitor  $C_T$  is now allowed to discharge at a rate determined by the off-time controller. The discharge current is made proportional to the output voltage to model the inductor current, which decays at a rate which is also proportional to the output voltage. While the timing capacitor is discharging, the N-gate output is high, turning on the N-channel MOSFET.

When the voltage on  $C_T$  has discharged past  $V_{TH1}$ , comparator T trips, setting the flip-flop. This causes the N-gate output to go low (turning off the N-channel MOSFET) and the P-gate output to also go low (turning the P-channel MOSFET back on). The cycle then repeats. As the load current

## OPERATION (Refer to Functional Diagram)

increases, the output voltage decreases slightly. This causes the output of the gain stage to increase the current comparator threshold, thus tracking the load current.

The sequence of events for Burst Mode operation is very similar to continuous operation with the cycle interrupted by the voltage comparator. When the output voltage is at or above the desired regulated value, the P-channel MOSFET is held off by comparator V and the timing capacitor continues to discharge below  $V_{TH1}$ . When the timing capacitor discharges past  $V_{TH2}$ , voltage comparator S trips, causing the internal SLEEP line to go low and the N-channel MOSFET to turn off.

The circuit now enters sleep mode with both power MOSFETs turned off. In sleep mode, much of the circuitry

is turned off, dropping the supply current from several milliamps (with the MOSFETs switching) to 300 $\mu$ A. When the output capacitor has discharged by the amount of hysteresis in comparator V, the P-channel MOSFET is again turned on and this process repeats. To avoid the operation of the current loop interfering with Burst Mode operation, a built-in offset is incorporated in the gain stage.

To prevent both the external MOSFETs from being turned on at the same time, feedback is incorporated to sense the state of the driver output pins. Before the N-gate output can go high, the P-drive output must also be high. Likewise, the P-drive output is prevented from going low when the N-gate output is high.

## APPLICATIONS INFORMATION

### The LTC1159 Compared to the LTC1148/LTC1149 Families

The LTC1159 family is closest in operation to the LTC1149 and shares much of the applications information. In addition to reduced quiescent and shutdown currents, the LTC1159 adds an internal switch which allows the driver and control sections to be powered from an external source for higher efficiency. This change affects Power MOSFET Selection, EXTV<sub>CC</sub> Pin Connection, Important Information About LTC1159 Adjustable Applications, and Efficiency Considerations found in this section.

The basic LTC1159 application circuit shown in Figure 1 is limited to a maximum input voltage of 30V due to MOSFET breakdown. If the application does not require greater than 18V operation, then the LTC1148 or LTC1148HV should be used. For higher input voltages where quiescent and shutdown current are not critical, the LTC1149 may be a better choice since it is set up to drive standard threshold MOSFETs.

### R<sub>SENSE</sub> Selection for Output Current

R<sub>SENSE</sub> is chosen based on the required output current. The LTC1159 current comparator has a threshold range that extends from a minimum of 0.025V/R<sub>SENSE</sub> to a maximum

of 0.15V/R<sub>SENSE</sub>. The current comparator threshold sets the peak of the inductor ripple current, yielding a maximum output current I<sub>MAX</sub> equal to the peak value less half the peak-to-peak ripple current. *For proper Burst Mode operation, I<sub>RIPPLE(P-P)</sub> must be less than or equal to the minimum current comparator threshold.*

Since efficiency generally increases with ripple current, the maximum allowable ripple current is assumed, i.e., I<sub>RIPPLE(P-P)</sub> = 0.025V/R<sub>SENSE</sub> (see C<sub>T</sub> and L Selection for Operating Frequency). Solving for R<sub>SENSE</sub> and allowing a margin for variations in the LTC1159 and external component values yields:

$$R_{SENSE} = \frac{100}{I_{MAX}} \text{ m}\Omega$$

A graph for selecting R<sub>SENSE</sub> versus maximum output current is given in Figure 2. The LTC1159 series works well with values of R<sub>SENSE</sub> from 0.02 $\Omega$  to 0.2 $\Omega$ .

The load current below which Burst Mode operation commences, I<sub>BURST</sub>, and the peak short-circuit current, I<sub>SC(PK)</sub>, both track I<sub>MAX</sub>. Once R<sub>SENSE</sub> has been chosen, I<sub>BURST</sub> and I<sub>SC(PK)</sub> can be predicted from the following equations:

## APPLICATIONS INFORMATION

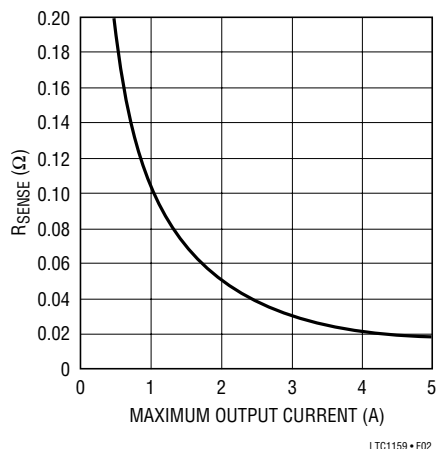


Figure 2. R<sub>SENSE</sub> vs Maximum Output Current

$$I_{BURST} \approx \frac{15\text{mV}}{R_{SENSE}}$$

$$I_{SC(PK)} = \frac{150\text{mV}}{R_{SENSE}}$$

The LTC1159 automatically extends  $t_{OFF}$  during a short circuit to allow sufficient time for the inductor current to decay between switch cycles. The resulting ripple current causes the average short-circuit current  $I_{SC(AVG)}$  to be reduced to approximately  $I_{MAX}$ .

### L and C<sub>T</sub> Selection for Operating Frequency

The LTC1159 uses a constant off-time architecture with  $t_{OFF}$  determined by an external timing capacitor  $C_T$ . The value of  $C_T$  is calculated from the desired continuous mode operating frequency,  $f$ :

$$C_T = \frac{7.8 \cdot 10^{-5}}{f} \left( 1 - \frac{V_{OUT}}{V_{IN}} \right)$$

A graph for selecting  $C_T$  versus frequency including the effects of input voltage is given in Figure 3.

As the operating frequency is increased the gate charge losses will be higher, reducing efficiency (see Efficiency Considerations). The complete expression for operating frequency is given by:

$$f = \frac{1}{t_{OFF}} \left( 1 - \frac{V_{OUT}}{V_{IN}} \right)$$

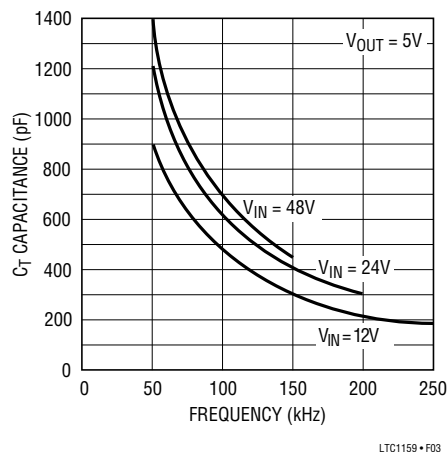


Figure 3. Timing Capacitor Selection

where  $t_{OFF} = 1.3 \cdot 10^4 \cdot C_T$

Once the frequency has been set by  $C_T$ , the inductor  $L$  must be chosen to provide no more than  $0.025V/R_{SENSE}$  of peak-to-peak inductor ripple current. This results in a minimum required inductor value of:

$$L_{MIN} = 5.1 \cdot 10^5 \cdot R_{SENSE} \cdot C_T \cdot V_{REG}$$

As the inductor value is increased from the minimum value, the ESR requirements for the output capacitor are eased at the expense of efficiency. If too small an inductor is used, the LTC1159 may not enter Burst Mode operation and efficiency will be severely degraded at low currents.

### Inductor Core Selection

Once the minimum value for  $L$  is known, the type of inductor must be selected. High efficiency converters generally cannot afford the core loss found in low cost powdered iron cores, forcing the use of more expensive ferrite, molypermalloy or Kool M $\mu$ ® cores. Actual core loss is independent of core size for a fixed inductor value, but it is very dependent on the inductance selected. As inductance increases, core losses go down but copper ( $I^2R$ ) losses will increase.

Ferrite designs have very low core loss, so design goals can concentrate on copper loss and preventing saturation. Ferrite core material saturates "hard," which means that inductance collapses abruptly when the peak design current is exceeded. This results in an abrupt increase in

Kool M $\mu$  is a registered trademark of Magnetics, Inc.

## APPLICATIONS INFORMATION

inductor ripple current and consequent output voltage ripple which can cause Burst Mode operation to be falsely triggered in the LTC1159. Do not allow the core to saturate!

Molypermalloy (from Magnetics, Inc.) is a low loss core material for toroids, but it is more expensive than ferrite. A reasonable compromise from the same manufacturer is Kool M $\mu$ . Toroids are very space efficient, especially when you can use several layers of wire. Because they generally lack a bobbin, mounting is more difficult. However, new surface mount designs available from Coiltronics do not increase the height significantly.

### Power MOSFET Selection

Two external power MOSFETs must be selected for use with the LTC1159: a P-channel MOSFET for the main switch and an N-channel MOSFET for the synchronous switch.

The peak-to-peak drive levels are set by the  $V_{CC}$  voltage on the LTC1159. This voltage is typically 4.5V during start-up and 5V to 7V during normal operation (see EXT $V_{CC}$  Pin Connection). Consequently, *logic-level threshold MOSFETs must be used in most LTC1159 family applications*. The only exception is applications in which EXT $V_{CC}$  is powered from an external supply greater than 8V, in which standard threshold MOSFETs ( $V_{GS(TH)} < 4V$ ) may be used. Pay close attention to the  $BV_{DSS}$  specification for the MOSFETs as well; many of the logic-level MOSFETs are limited to 30V.

Selection criteria for the power MOSFETs include the “ON” resistance  $R_{DS(ON)}$ , reverse transfer capacitance  $C_{RSS}$ , input voltage and maximum output current. When the LTC1159 is operating in continuous mode, the duty cycle for the P-channel MOSFET is given by:

$$\text{P-Ch Duty Cycle} = \frac{V_{OUT}}{V_{IN}}$$

$$\text{N-Ch Duty Cycle} = \frac{V_{IN} - V_{OUT}}{V_{IN}}$$

The MOSFET dissipations at maximum output current are given by:

$$\text{P-Ch } P_D = \frac{V_{OUT}}{V_{IN}} (I_{MAX})^2 (1 + \partial_P) R_{DS(ON)} + k(V_{IN})^2 (I_{MAX}) (C_{RSS}) (f)$$

$$\text{N-Ch } P_D = \frac{V_{IN} - V_{OUT}}{V_{IN}} (I_{MAX})^2 (1 + \partial_N) R_{DS(ON)}$$

where  $\partial$  is the temperature dependency of  $R_{DS(ON)}$  and  $k$  is a constant inversely related to the gate drive current.

Both MOSFETs have  $I^2R$  losses while the P-channel equation includes an additional term for transition losses, which are highest at high input voltages. For  $V_{IN} < 20V$  the high current efficiency generally improves with larger MOSFETs, while for  $V_{IN} > 20V$  the transition losses rapidly increase to the point that the use of a higher  $R_{DS(ON)}$  device with lower  $C_{RSS}$  actually provides higher efficiency. The N-channel MOSFET losses are the greatest at high input voltage or during a short circuit when the N-channel duty cycle is nearly 100%.

The term  $(1 + \partial)$  is generally given for a MOSFET in the form of a normalized  $R_{DS(ON)}$  vs Temperature curve, but  $\partial = 0.007/^{\circ}C$  can be used as an approximation for low voltage MOSFETs.  $C_{RSS}$  is usually specified in the MOSFET electrical characteristics. The constant  $k=5$  can be used for the LTC1159 to estimate the relative contributions of the two terms in the P-channel dissipation equation.

The Schottky diode D1 shown in Figure 1 only conducts during the dead time between the conduction of the two power MOSFETs. D1 prevents the body diode of the N-channel MOSFET from turning on and storing charge during the dead time, which could cost as much as 1% in efficiency (although there are no other harmful effects if D1 is omitted). Therefore, D1 should be selected for a forward voltage of less than 0.6V when conducting  $I_{MAX}$ .

## APPLICATIONS INFORMATION

### C<sub>IN</sub> and C<sub>OUT</sub> Selection

In continuous mode, the source current of the P-channel MOSFET is a square wave of duty cycle  $V_{OUT}/V_{IN}$ . To prevent large voltage transients, a low ESR input capacitor sized for the maximum RMS current must be used. The maximum RMS capacitor current is given by:

$$C_{IN} \text{ Required } I_{RMS} \approx \frac{I_{MAX} [V_{OUT}(V_{IN} - V_{OUT})]^{1/2}}{V_{IN}}$$

This formula has a maximum at  $V_{IN} = 2V_{OUT}$ , where  $I_{RMS} = I_{MAX}/2$ . This simple worst-case condition is commonly used for design because even significant deviations do not offer much relief. Note that capacitor manufacturer's ripple current ratings are often based on only 2000 hours of life. This makes it advisable to further derate the capacitor, or to choose a capacitor rated at a higher temperature than required. Several capacitors may be paralleled to meet size or height requirements in the design. An additional 0.1  $\mu$ F ceramic capacitor may also be required on  $V_{IN}$  for high frequency decoupling.

The selection of  $C_{OUT}$  is driven by the required effective series resistance (ESR). The ESR of  $C_{OUT}$  must be less than twice the value of  $R_{SENSE}$  for proper operation of the LTC1159:

$$C_{OUT} \text{ Required ESR} < 2R_{SENSE}$$

Optimum efficiency is obtained by making the ESR equal to  $R_{SENSE}$ . Manufacturers such as Nichicon, Chemicon, and Sprague should be considered for high performance capacitors. The OS-CON semiconductor dielectric capacitor available from Sanyo has the lowest ESR for its size at a somewhat higher price. Once the ESR requirement for  $C_{OUT}$  has been met, the RMS current rating generally far exceeds the  $I_{RIPPLE(P-P)}$  requirement.

In surface mount applications, multiple capacitors may have to be paralleled to meet the capacitance, ESR or RMS current handling requirements of the application. Aluminum electrolytic and dry tantalum capacitors are both available in surface mount configurations. In the case of tantalum, it is critical that the capacitors are surge tested for use in switching power supplies. An excellent choice is the AVX TPS series of surface mount tantalums, available in case heights ranging from 2mm to 4mm. For example,

if 200 $\mu$ F/10V is called for in an application requiring 3mm height, two AVX 100 $\mu$ F/10V (P/N TPSD107K010) could be used. Consult the manufacturer for other specific recommendations.

At low supply voltages, a minimum value of  $C_{OUT}$  is suggested to prevent an abnormal low frequency operating mode (see Figure 4). When  $C_{OUT}$  is too small, the output ripple at low frequencies will be large enough to trip the voltage comparator. This causes the Burst Mode operation to be activated when the LTC1159 would normally be in continuous operation. The effect is most pronounced with low values of  $R_{SENSE}$  and can be improved by operating at higher frequencies with lower values of L. The output remains in regulation at all times.

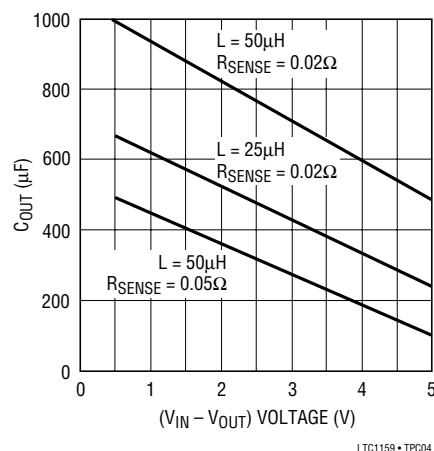


Figure 4. Minimum Suggested C<sub>OUT</sub>

### Load Transient Response

Switching regulators take several cycles to respond to a step in DC (resistive) load current. When a load step occurs,  $V_{OUT}$  shifts by an amount equal to  $\Delta I_{LOAD} \cdot ESR$ , where ESR is the effective series resistance of  $C_{OUT}$ .  $\Delta I_{LOAD}$  also begins to charge or discharge  $C_{OUT}$  until the regulator loop adapts to the current change and returns  $V_{OUT}$  to its steady-state value. During this recovery time  $V_{OUT}$  can be monitored for overshoot or ringing which would indicate a stability problem. The  $I_{TH}$  external components shown in the Figure 1 circuit will provide adequate compensation for most applications.

A second, more severe transient is caused by switching in loads with large (>1 $\mu$ F) supply bypass capacitors. The

## APPLICATIONS INFORMATION

discharged bypass capacitors are effectively put in parallel with  $C_{OUT}$ , causing a rapid drop in  $V_{OUT}$ . No regulator can deliver enough current to prevent this problem if the load switch resistance is low and it is driven quickly. The only solution is to limit the rise time of the switch drive so that the load rise time is limited to approximately  $25 \cdot C_{LOAD}$ . Thus a  $10\mu\text{F}$  capacitor would require a  $250\mu\text{s}$  rise time, limiting the charging current to about 200mA.

### Line Transient Response

The LTC1159 has better than 60dB line rejection and is generally impervious to large positive or negative line voltage transients. However, one rarely occurring condition can cause the output voltage to overshoot if the proper precautions are not observed. This condition is a negative  $V_{IN}$  transition of several volts followed within  $100\mu\text{s}$  by a positive transition of greater than  $0.5\text{V}/\mu\text{s}$  slew rate.

The reason this condition rarely occurs is because it takes tens of amps to slew the regulator input capacitor at this rate! The solution is to add a diode between the cap and  $V_{IN}$  pins of the LTC1159 as shown in several of the typical application circuits. If you think your system could have this problem, add the diode. Note that in surface mount applications it can be combined with the P-gate diode by using a low cost common cathode dual diode.

### EXTV<sub>CC</sub> Pin Connection

The LTC1159 contains an internal PNP switch connected between the EXTV<sub>CC</sub> and  $V_{CC}$  pins. The switch closes and supplies the  $V_{CC}$  power whenever the EXTV<sub>CC</sub> pin is higher in voltage than the 4.5V internal regulator. This allows the

MOSFET driver and control power to be derived from the output during normal operation and from the internal regulator when the output is out of regulation (start-up, short circuit).

Significant efficiency gains can be realized by powering  $V_{CC}$  from the output, since the  $V_{IN}$  current resulting from the driver and control currents will be scaled by a factor of (Duty Cycle)/(Efficiency). For 5V regulators this simply means connecting the EXTV<sub>CC</sub> pin directly to  $V_{OUT}$ . However, for 3.3V and other low voltage regulators, additional circuitry is required to derive  $V_{CC}$  power from the output.

The following list summarizes the four possible connections for EXTV<sub>CC</sub>:

1. EXTV<sub>CC</sub> Left Open. This will cause  $V_{CC}$  to be powered only from the internal 4.5V regulator resulting in reduced MOSFET gate drive levels and an efficiency penalty of up to 10% at high input voltages.
2. EXTV<sub>CC</sub> Connected Directly to  $V_{OUT}$ . This is the normal connection for a 5V regulator and provides the highest efficiency.
3. EXTV<sub>CC</sub> Connected to an Output-Derived Boost Network. For 3.3V and other low voltage regulators, efficiency gains can still be realized by connecting EXTV<sub>CC</sub> to an output-derived voltage which has been boosted to greater than 4.5V. This can be done either with the inductive boost winding shown in Figure 5a or the capacitive charge pump shown in Figure 5b. The charge pump has the advantage of simple magnetics and generally provides the highest efficiency at the expense of a slightly higher parts count.

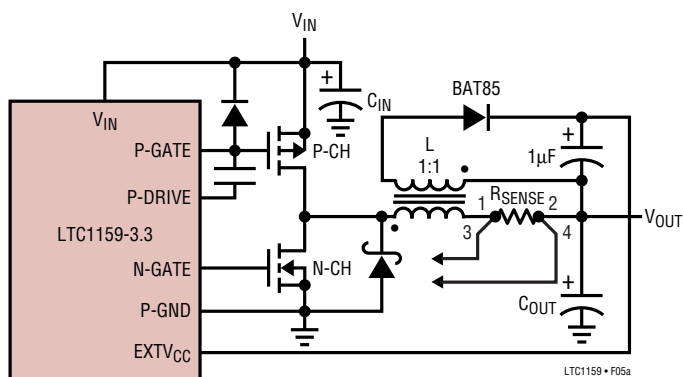


Figure 5a. Inductive Boost Circuit for EXTV<sub>CC</sub>

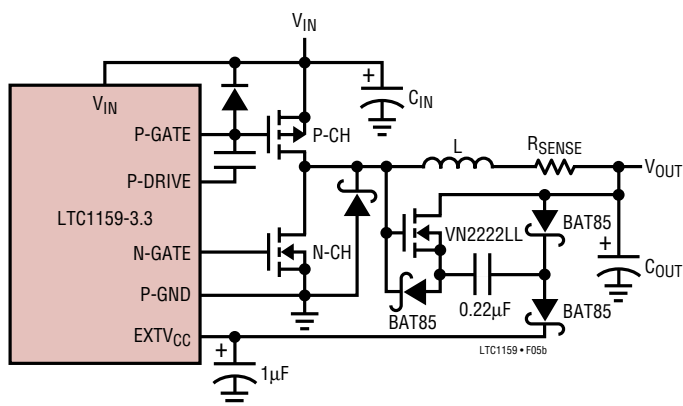


Figure 5b. Capacitive Charge Pump for EXTV<sub>CC</sub>

## APPLICATIONS INFORMATION

4.  $\text{EXTV}_{\text{CC}}$  Connected to an External Supply. If an external supply is available in the 5V to 12V range, it may be used to power  $\text{EXTV}_{\text{CC}}$  providing it is compatible with the MOSFET gate drive requirements. There are no restrictions on the  $\text{EXTV}_{\text{CC}}$  voltage relative to  $V_{\text{IN}}$ .  $\text{EXTV}_{\text{CC}}$  may be higher than  $V_{\text{IN}}$  providing  $\text{EXTV}_{\text{CC}}$  does not exceed the 15V absolute maximum rating.

*When driving standard threshold MOSFETs, the external supply must always be present during operation to prevent MOSFET failure due to insufficient gate drive. The LTC1149 family should also be considered for applications which require the use of standard threshold MOSFETs.*

## Important Information About LTC1159 Adjustable Applications

When an output voltage other than 3.3V or 5V is required, the LTC1159 adjustable version is used with an external resistive divider from  $V_{OUT}$  to the  $V_{FB}$  pin (Figure 6). The regulated voltage is determined by:

$$V_{OUT} = \left(1 + \frac{R2}{R1}\right) 1.25V$$

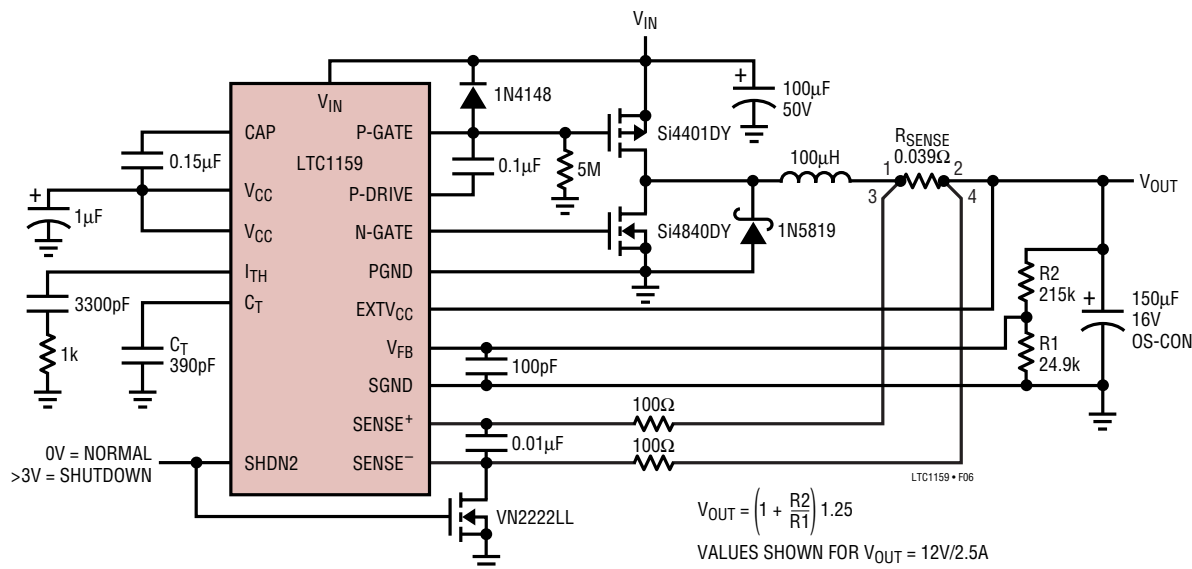
*The  $V_{FB}$  pin is extremely sensitive to pickup from the inductor switching node. Care should be taken to isolate the feedback network from the inductor, and the 100pF capacitor should be connected between the  $V_{FB}$  and SGND pins next to the package.*

In LTC1159N and LTC1159S applications with  $V_{OUT} > 5.5V$ , the  $V_{CC}$  pin may self-power through the SENSE pins when SHDN2 is taken high, preventing shutdown. In these applications, a pull-down must be added to the SENSE $^-$  pin as shown in Figure 6. This pull-down effectively takes the place of the SHDN1 pin, ensuring complete shutdown. Note: For versions in which both the SHDN1 and SHDN2 pins are available (LTC1159G and all fixed output versions), the two pins are simply connected to each other and driven together to guarantee complete shutdown.

The Figure 6 circuit cannot be used to regulate a  $V_{OUT}$  which is greater than the maximum voltage allowed on the LTC1159 SENSE pins (13V). In applications with  $V_{OUT} > 13V$ ,  $R_{SENSE}$  must be moved to the ground side of the output capacitor and load. This operates the current sense comparator at 0V common mode, increasing the off-time approximately 40% and requiring the use of a smaller timing capacitor  $C_T$ .

## Inverting Regular Applications

The LTC1159 can also be used to obtain negative output voltages from positive inputs. In these inverting applications, the current sense resistor connects to ground while the LTC1159 and N-channel MOSFET connections, which would normally go to ground, instead ride on the negative output. This allows the negative output voltage to be set by



**Figure 6. High Efficiency Adjustable Regulator with  $5.5V < V_{OUT} < 13V$**

## APPLICATIONS INFORMATION

the same process as in conventional applications, using either the internal divider (LTC1159-3.3, LTC1159-5) or an external divider with the adjustable version.

Figure 15 in the Typical Applications shows a synchronous 12V to –12V converter that can supply up to 1A with better than 85% efficiency. By grounding the EXTV<sub>CC</sub> pin in the Figure 15 circuit, the entire 12V output voltage is placed across the driver and control circuits since the LTC1159 ground pins are at –12V. During start-up or short-circuit conditions, operating power is supplied by the internal 4.5V regulator. The shutdown signal is level-shifted to the negative output rail by Q3, and Q4 ensures that Q1 and Q2 remain off during the entire shutdown sequence.

### Efficiency Considerations

The percent efficiency of a switching regulator is equal to the output power divided by the input power times 100%. It is often useful to analyze individual losses to determine what is limiting the efficiency and which change would produce the most improvement. Percent efficiency can be expressed as:

$$\% \text{Efficiency} = 100 - (L1 + L2 + L3 + \dots)$$

where L1, L2, etc., are the individual losses as a percentage of input power.

Although all dissipative elements in the circuit produce losses, four main sources usually account for most of the losses in LTC1159 circuits: 1) LTC1159 V<sub>IN</sub> current, 2) LTC1159 V<sub>CC</sub> current, 3) I<sup>2</sup>R losses and 4) P-channel transition losses.

1. LTC1159 V<sub>IN</sub> current is the DC supply current given in the electrical characteristics which excludes MOSFET driver and control currents. V<sub>IN</sub> current results in a small (< 1%) loss which increases with V<sub>IN</sub>.
2. LTC1159 V<sub>CC</sub> current is the sum of the MOSFET driver and control circuit currents. The MOSFET driver current results from switching the gate capacitance of the power MOSFETs. Each time a MOSFET gate is switched from low to high to low again, a packet of charge dQ moves from V<sub>CC</sub> to ground. The resulting dQ/dt is a current out of V<sub>CC</sub> which is typically much larger than the control circuit current. In continuous mode, I<sub>GATECHG</sub> ≈ f(Q<sub>P</sub> + Q<sub>N</sub>), where Q<sub>P</sub> and Q<sub>N</sub> are the gate charges of the two MOSFETs.

By powering EXTV<sub>CC</sub> from an output-derived source, the additional V<sub>IN</sub> current resulting from the driver and control currents will be scaled by a factor of (Duty Cycle)/(Efficiency). For example in a 20V to 5V application, 10mA of V<sub>CC</sub> current results in approximately 3mA of V<sub>IN</sub> current. This reduces the mid-current loss from 10% or more (if the driver was powered directly from V<sub>IN</sub>) to only a few percent.

3. I<sup>2</sup>R losses are easily predicted from the DC resistances of the MOSFET, inductor and current shunt. In continuous mode all of the output current flows through L and R<sub>SENSE</sub>, but is “chopped” between the P-channel and N-channel MOSFETs. If the two MOSFETs have approximately the same R<sub>DS(ON)</sub>, then the resistance of one MOSFET can simply be summed with the resistances of L and R<sub>SENSE</sub> to obtain I<sup>2</sup>R losses. For example, if each R<sub>DS(ON)</sub> = 0.1Ω, R<sub>L</sub> = 0.15Ω, and R<sub>SENSE</sub> = 0.05Ω, then the total resistance is 0.3Ω. This results in losses ranging from 3% to 12% as the output current increases from 0.5A to 2A. I<sup>2</sup>R losses cause the efficiency to roll-off at high output currents.

4. Transition losses apply only to the P-channel MOSFET, and only when operating at high input voltages (typically 20V or greater). Transition losses can be estimated from:

$$\text{Transition Loss} \approx 5(V_{IN})^2(I_{MAX})(C_{RSS})(f)$$

Other losses including C<sub>IN</sub> and C<sub>OUT</sub> ESR dissipative losses, Schottky conduction losses during dead time, and inductor core losses, generally account for less than 2% total additional loss.

### Auxiliary Windings—Suppressing Burst Mode Operation

The LTC1159 synchronous switch removes the normal limitation that power must be drawn from the inductor primary winding in order to extract power from auxiliary windings. With synchronous switching, auxiliary outputs may be loaded without regard to the primary output load, providing that the loop remains in continuous mode operation.

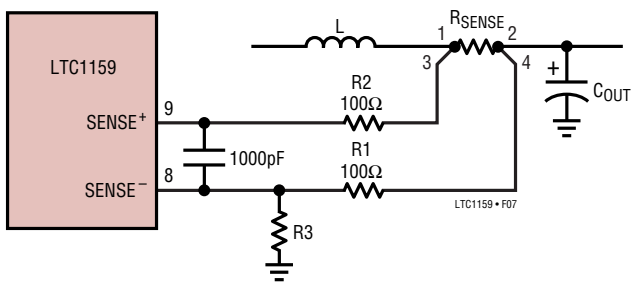
Burst Mode operation can be suppressed at low output currents with a simple external network that cancels the 0.025V minimum current comparator threshold. This technique is also useful for eliminating audible noise from

## APPLICATIONS INFORMATION

certain types of inductors in high current ( $I_{OUT} > 5A$ ) applications when they are lightly loaded.

An external offset is put in series with the SENSE<sup>-</sup> pin to subtract from the built-in 0.025V offset. An example of this technique is shown in Figure 7. Two 100Ω resistors are inserted in series with the leads from the sense resistor. With the addition of R3, a current is generated through R1 causing an offset of:

$$V_{\text{OFFSET}} = V_{\text{OUT}} \left( \frac{R1}{R1 + R3} \right)$$



### Figure 7. Suppressing Burst Mode Operation

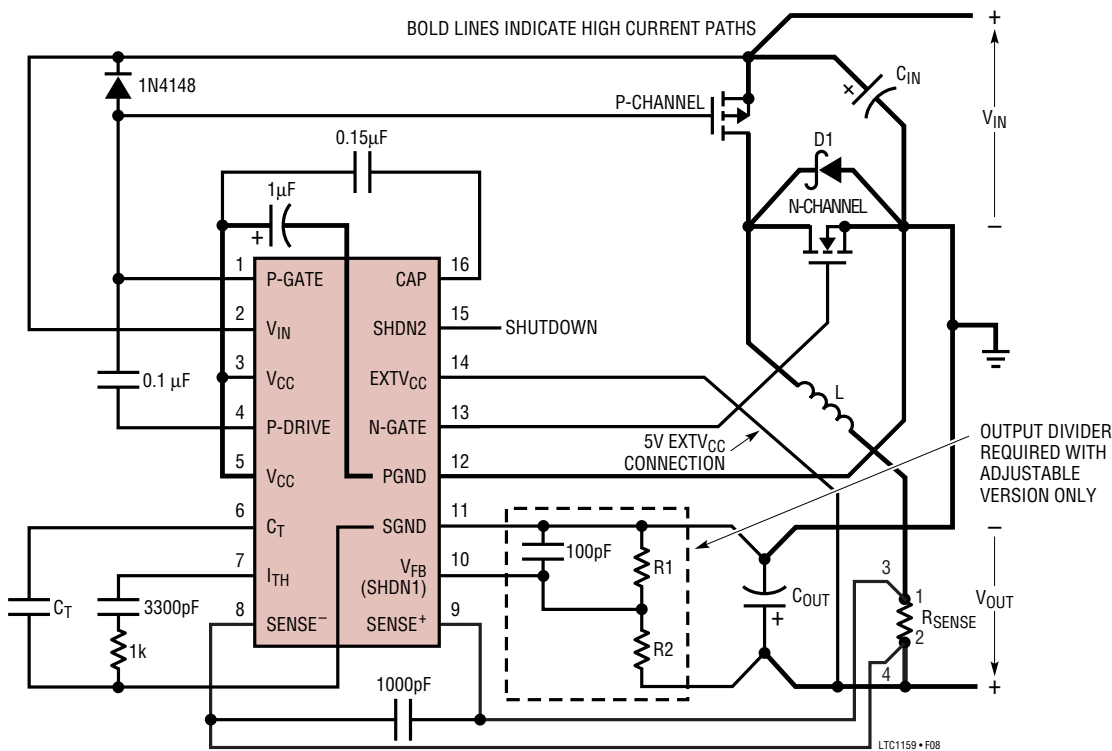
If  $V_{\text{OFFSET}} > 0.025\text{V}$ , the minimum threshold will be cancelled and Burst Mode operation is prevented from occurring. Since  $V_{\text{OFFSET}}$  is constant, the maximum load current is also decreased by the same offset. Thus, to get back to the same  $I_{\text{MAX}}$ , the value of the sense resistor must be reduced:

$$R_{\text{SENSE}} \approx \frac{75}{I_{\text{MAX}}} \text{ m}\Omega$$

To prevent noise spikes from erroneously tripping the current comparator, a 1000pF capacitor is needed across the SENSE<sup>-</sup> and SENSE<sup>+</sup> pins.

## Board Layout Checklist

When laying out the printed circuit board, the following checklist should be used to ensure proper operation of the LTC1159. These items are also illustrated graphically in the layout diagram of Figure 8. Check the following in your layout:



**Figure 8. LTC1159 Layout Diagram (N and S Packages)**

## APPLICATIONS INFORMATION

1) Are the signal and power grounds segregated? The LTC1159 signal ground must connect separately to the (–) plate of  $C_{OUT}$ . The other ground pin(s) should return to the source of the N-channel MOSFET, anode of the Schottky diode and (–) plate of  $C_{IN}$ , which should have as short lead lengths as possible.

2) Does the LTC1159  $SENSE^-$  pin connect to a point close to  $R_{SENSE}$  and the (+) plate of  $C_{OUT}$ ? In adjustable applications, the resistive divider  $R1$ ,  $R2$  must be connected between the (+) plate of  $C_{OUT}$  and signal ground.

3) Are the  $SENSE^-$  and  $SENSE^+$  leads routed together with minimum PC trace spacing? The differential decoupling capacitor between the two  $SENSE$  pins should be as close as possible to the LTC1159. Up to  $100\Omega$  may be placed in series with each sense lead to help decouple the  $SENSE$  pins. However, when these resistors are used, the capacitor should be no larger than  $1000pF$ .

4) Does the (+) plate of  $C_{IN}$  connect to the source of the P-channel MOSFET as closely as possible? An additional  $0.1\mu F$  ceramic capacitor between  $V_{IN}$  and power ground may be required in some applications.

5) Is the  $V_{CC}$  decoupling capacitor connected closely between the  $V_{CC}$  pins of the LTC1159 and power ground? This capacitor carries the MOSFET driver peak currents.

6) In adjustable versions, the feedback pin is very sensitive to pickup from the switch node. Care must be taken to isolate  $V_{FB}$  from possible capacitive coupling of the inductor switch signal.

7) Is the  $SHDN1$  pin actively pulled to ground during normal operation?  $SHDN1$  is a high impedance pin and must not be allowed to float.

### Troubleshooting Hints

Since efficiency is critical to LTC1159 applications it is very important to verify that the circuit is functioning correctly in both continuous and Burst Mode operation. The waveform to monitor is the voltage on the  $C_T$  pin.

In continuous mode ( $I_{LOAD} > I_{BURST}$ ) the voltage should be a sawtooth with a  $0.9V_{P-P}$  swing. This voltage should never dip below  $2V$  as shown in Figure 9a. When the load current is low ( $I_{LOAD} < I_{BURST}$ ), Burst Mode operation should occur with the  $C_T$  waveform periodically falling to ground as shown in Figure 9b.

If the  $C_T$  pin is observed falling to ground at high output currents, it indicates poor decoupling or improper grounding. Refer to the Board Layout Checklist.

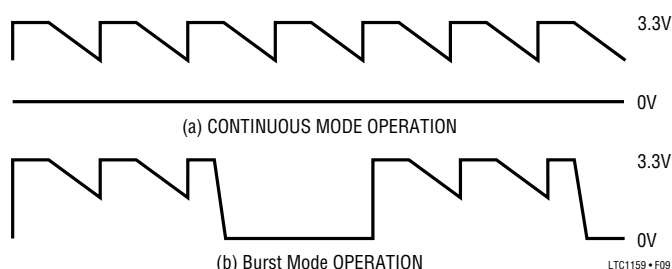


Figure 9.  $C_T$  Pin 6 Waveforms

## TYPICAL APPLICATIONS

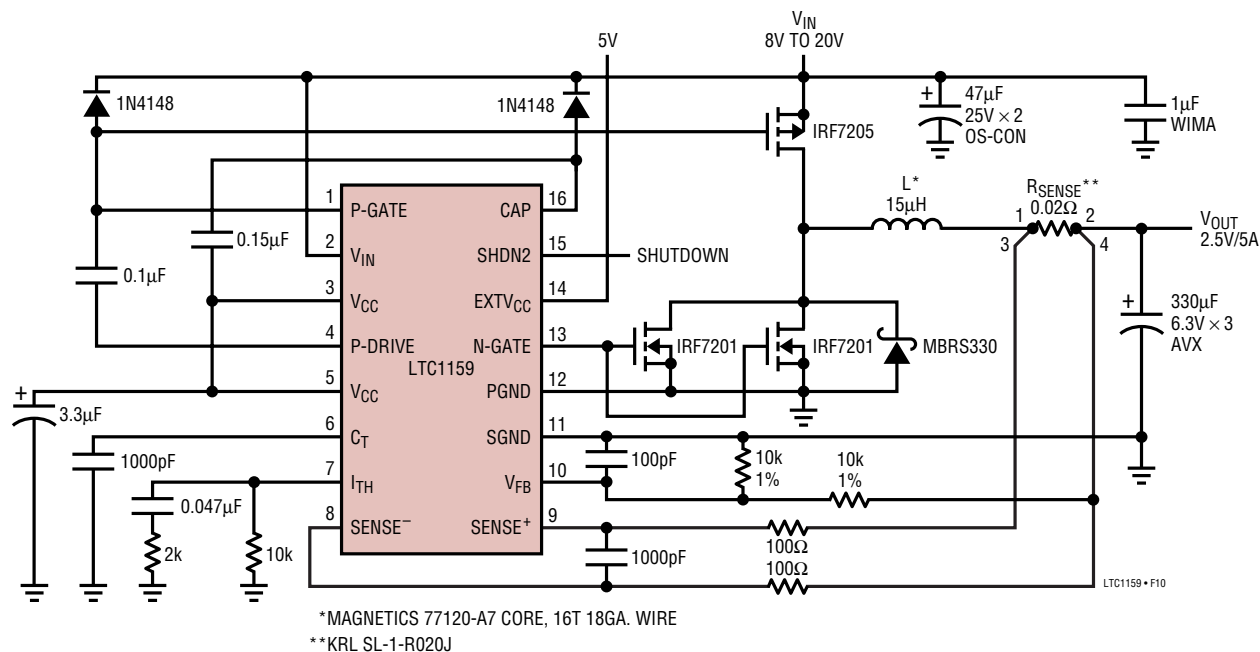


Figure 10. High Efficiency 8V to 20V Input 2.5/5A Output Regulator

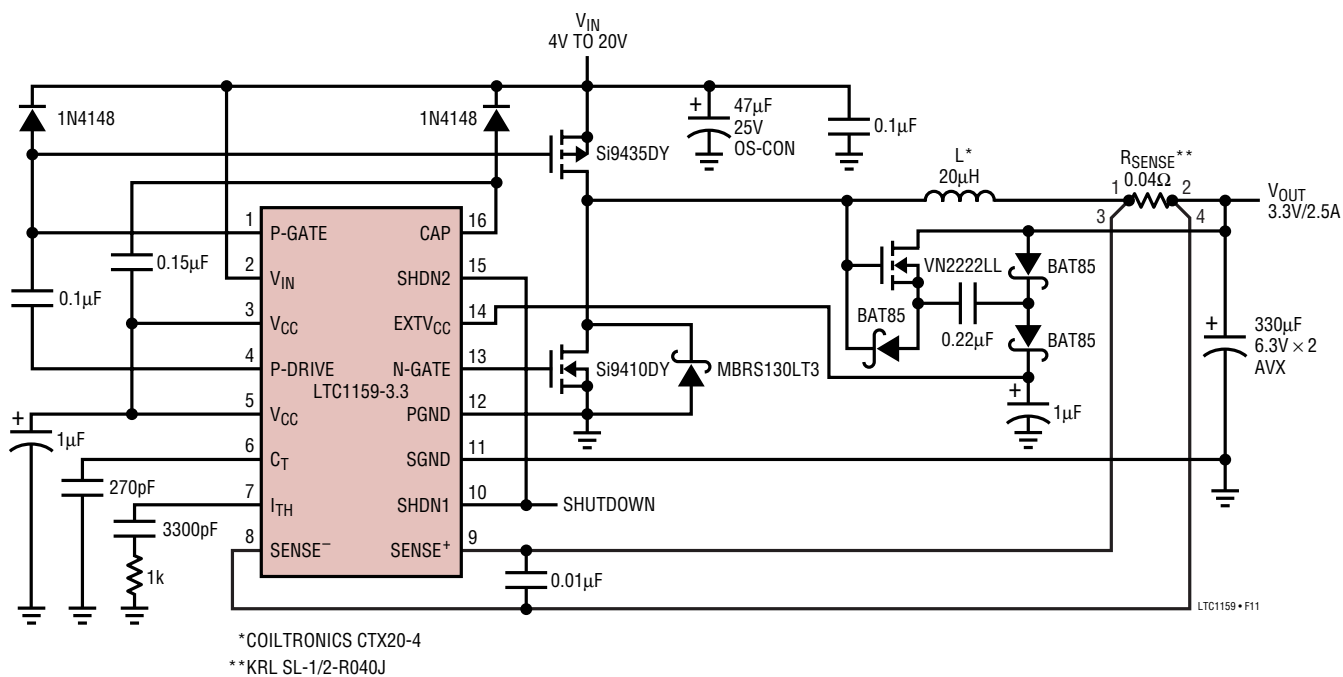


Figure 11. 5:1 Input Range (4V to 20V) High Efficiency 3.3V/2.5A Regulator

## TYPICAL APPLICATIONS

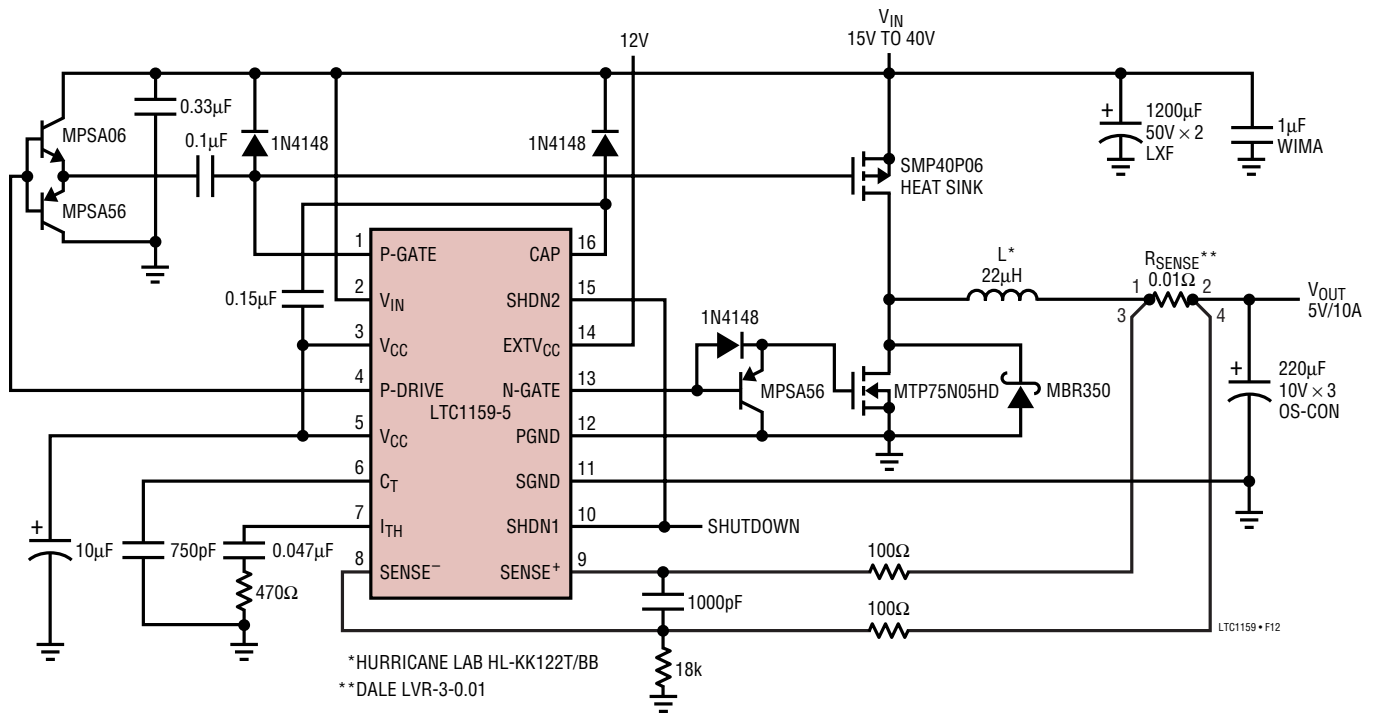


Figure 12. High Current, High Efficiency 15V to 40V Input 5V/10A Output Regulator

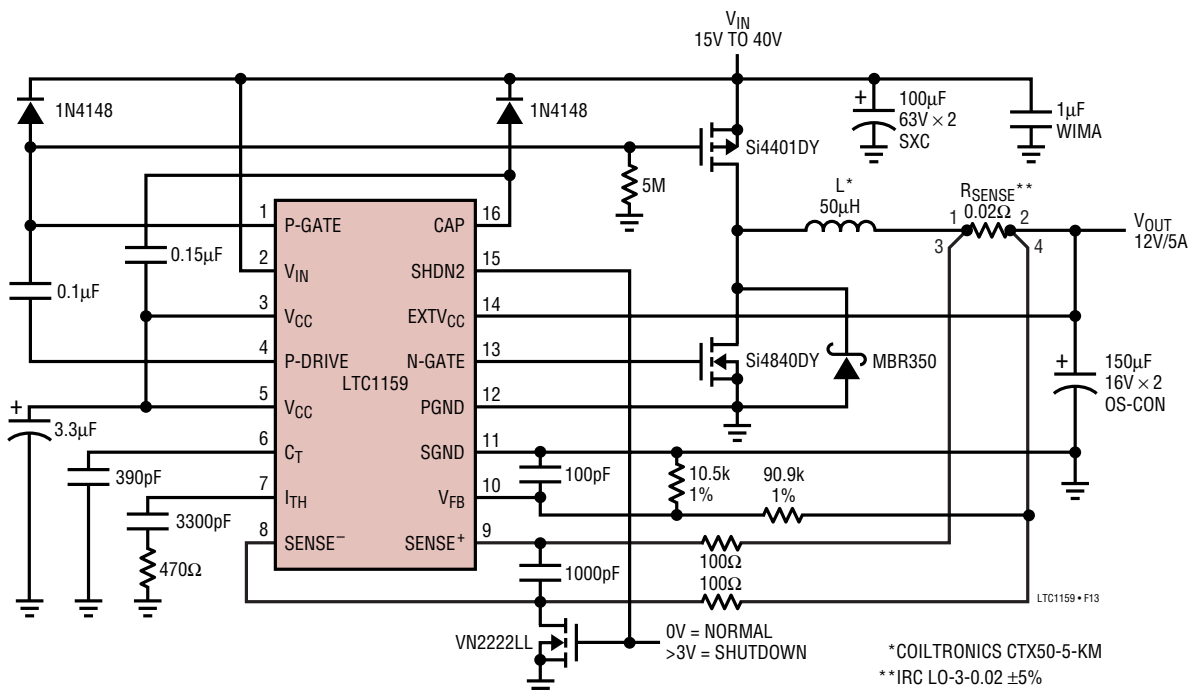


Figure 13. High Efficiency 15V to 40V Input 12V/5A Output Regulator

## TYPICAL APPLICATIONS

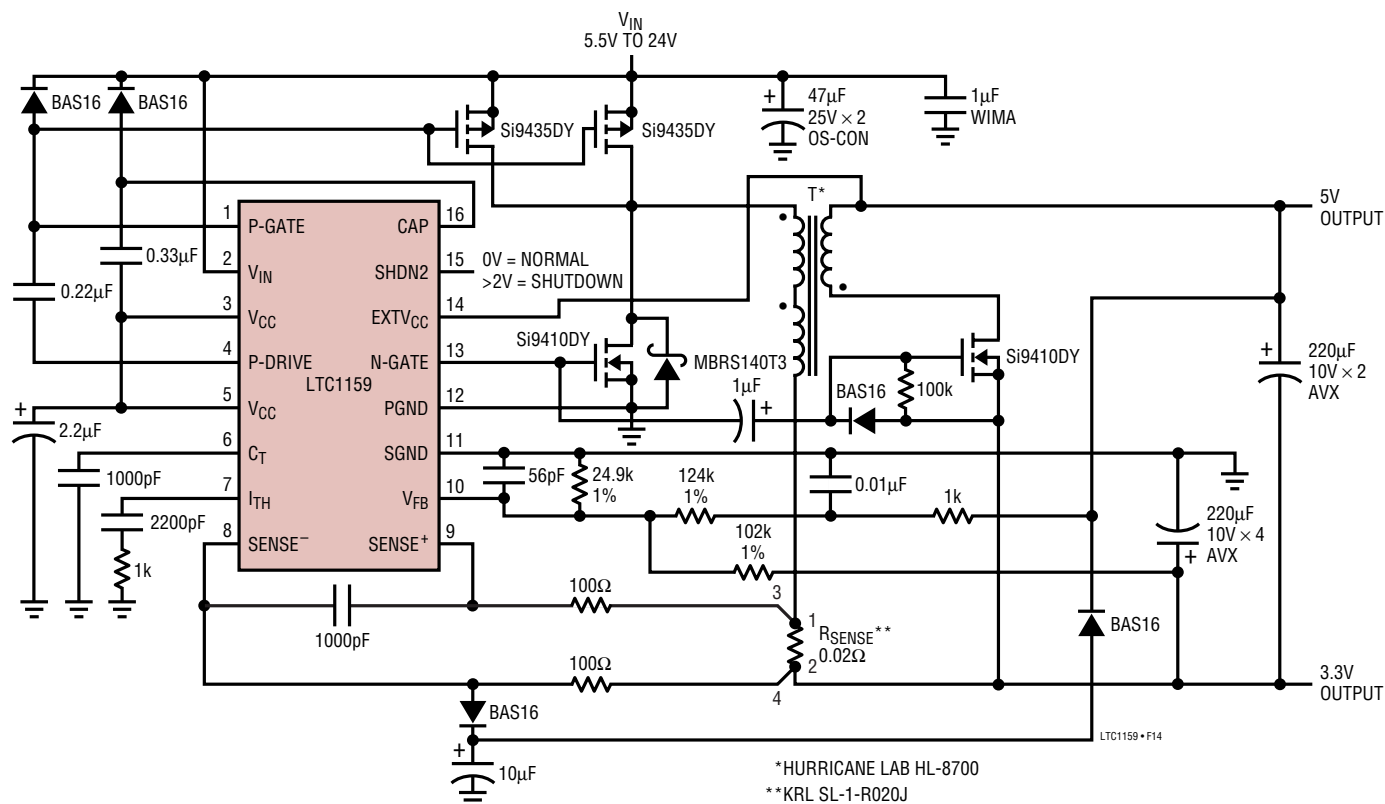
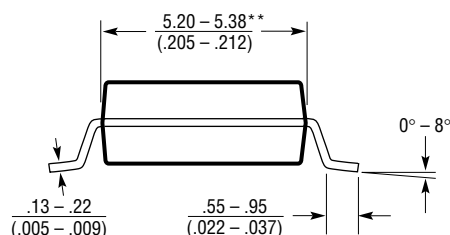


Figure 14. 17W Dual Output High Efficiency 5V and 3.3V Regulator

## PACKAGE DESCRIPTION

**G Package**  
**20-Lead Plastic SSOP (5.3mm)**  
(Reference LTC DWG # 05-08-1640)



NOTE:

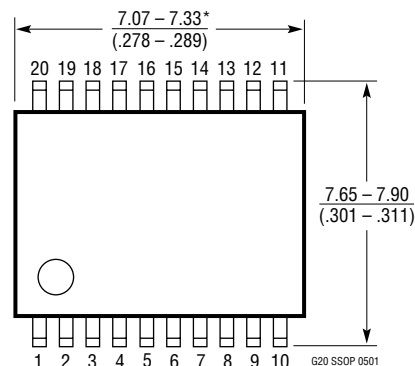
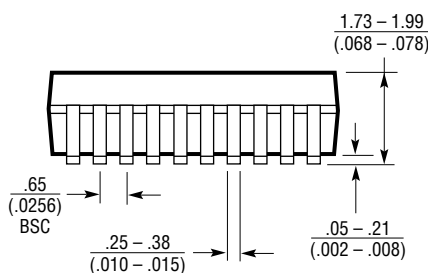
1. CONTROLLING DIMENSION: MILLIMETERS

2. DIMENSIONS ARE IN MILLIMETERS  
(INCHES)

3. DRAWING NOT TO SCALE

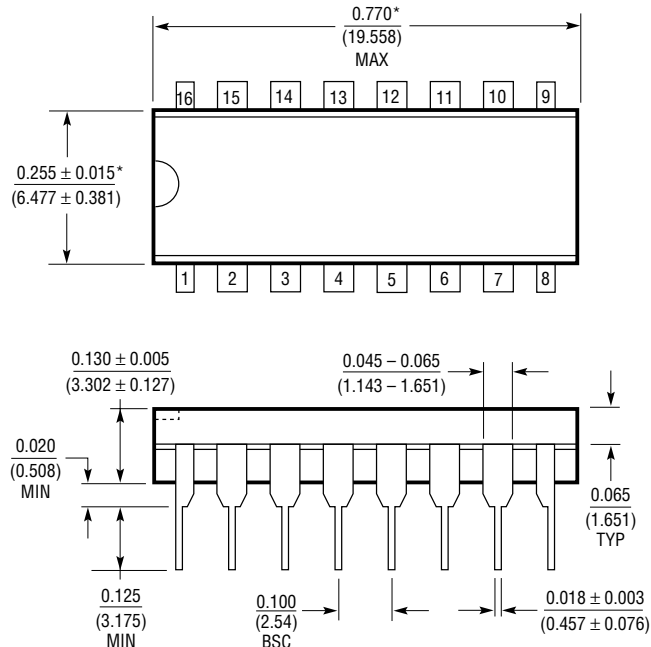
\*DIMENSIONS DO NOT INCLUDE MOLD FLASH. MOLD FLASH  
SHALL NOT EXCEED .152mm (.006") PER SIDE

\*\*DIMENSIONS DO NOT INCLUDE INTERLEAD FLASH. INTERLEAD  
FLASH SHALL NOT EXCEED .254mm (.010") PER SIDE



## PACKAGE DESCRIPTION

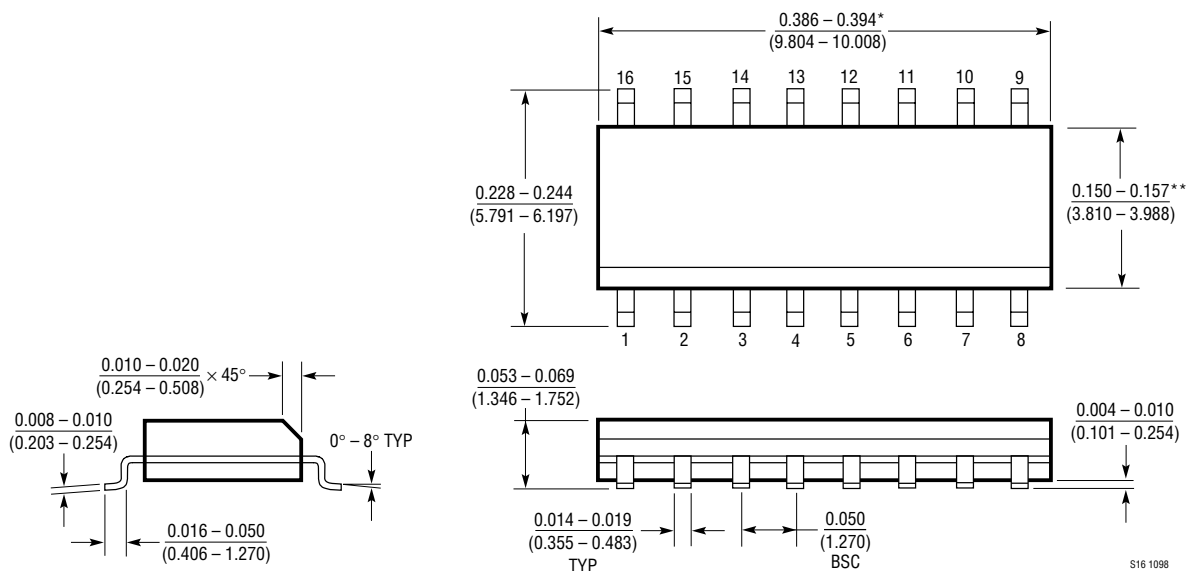
### N Package 16-Lead PDIP (Narrow .300 Inch) (Reference LTC DWG # 05-08-1510)



\*THESE DIMENSIONS DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS.  
MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.010 INCH (0.254mm)

N16 1098

### S Package 16-Lead Plastic Small Outline (Narrow .150 Inch) (Reference LTC DWG # 05-08-1610)



\*DIMENSION DOES NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED 0.006" (0.152mm) PER SIDE

\*\*DIMENSION DOES NOT INCLUDE INTERLEAD FLASH. INTERLEAD FLASH SHALL NOT EXCEED 0.010" (0.254mm) PER SIDE

S16 1098

TYPICAL APPLICATION

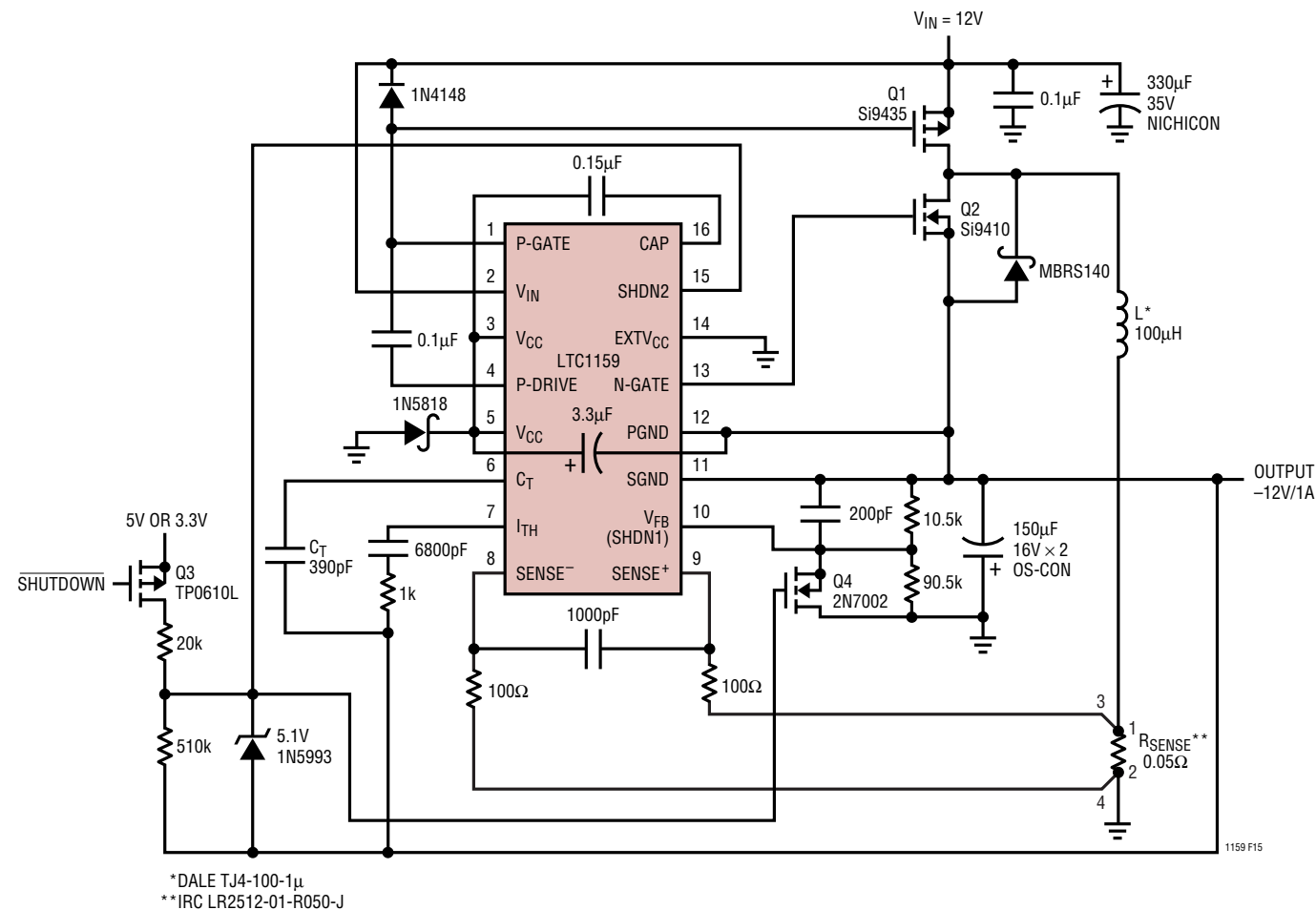


Figure 15. High Efficiency 12V to -12V 1A Converter

RELATED PARTS

| PART NUMBER | DESCRIPTION                                     | COMMENTS                                                                                         |
|-------------|-------------------------------------------------|--------------------------------------------------------------------------------------------------|
| LTC1628     | 2-Phase, Dual Step-Down Controller              | $V_{IN} \leq 36V$ , Minimum $C_{IN}$ , Current Mode                                              |
| LTC1702     | 550kHz Dual, 2-Phase Step-Down Controller       | Minimum $C_{IN}$ , No Sense Resistor Required, $V_{IN} \leq 7V$                                  |
| LTC1735     | Synchronous Step-Down Controller                | $3.5V \leq V_{IN} \leq 36V$ , $0.8V \leq V_{OUT} \leq 6V$ , Synchronizable                       |
| LTC1773     | 550kHz Synchronous Step-Down Controller         | $2.65V \leq V_{IN} \leq 8.5V$ , $0.8V \leq V_{OUT} \leq V_{IN}$ , Synchronizable to 750kHz, MS10 |
| LTC1778     | No $R_{SENSE}^{\text{TM}}$ Step-Down Controller | No Sense Resistor Required, $t_{ON(MIN)} \leq 100ns$ , Current Mode, GN16                        |
| LTC1876     | Triple Output, 2-Phase Controller               | Two, 2-Phase Step-Down Controllers and Step-Up DC/DC Converter in One IC                         |

No  $R_{SENSE}$  is a trademark of Linear Technology Corporation.